



# Product Change Notification

## 112872 - 00

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# Product Change Notification

**Change Notification #:** 112872 - 00  
**Change Title:** Intel® Centrino® Ultimate-N 6300 SKUs:  
633AN.HMWWB; 633AN.HMWEBC;  
633AN.HMWG; 633AN.HMIG  
PCN 112872-00, Label, Manufacturing Site

**Label Update and Manufacturing Site  
Change**

**Date of Publication:** February 14, 2014

## Key Characteristics of the Change:

Label, Manufacturing Site

## Forecasted Key Milestones:

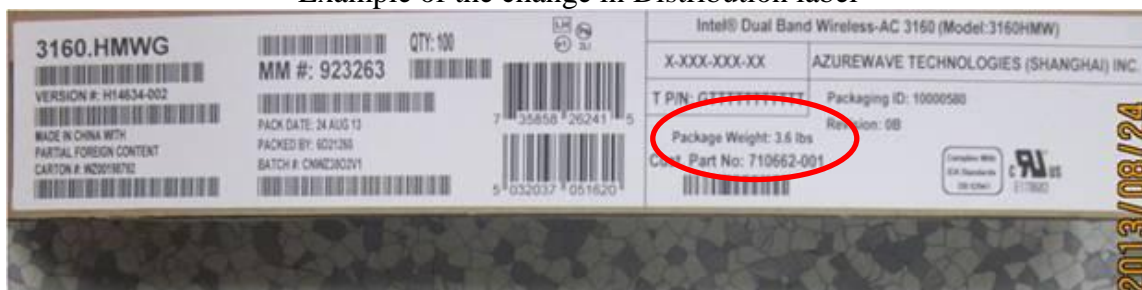
<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Mar 19, 2014
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## Description of Change to the Customer:

The Intel® Centrino® Ultimate-N 6300 products documented in this PCN will undergo the following changes:

1. Intel will update Carton Label Weight - from 3.6 to 1.2 lbs. on the SKUs listed in this PCN.

Example of the change in Distribution label



The above label is representation for example purposes only. The actual label will reflect correct product data.

2. Intel will be adding the WDM4 site for the manufacturing for Intel® Centrino® Ultimate-N 6300 SKUs listed in this PCN. As a result of this action the WDM4 site code will be added on product label and distribution label, WDM4 = CX. The WDM4 site has been fully qualified and will be building product using the same components and processes as the existing manufacturing site.

Current site	Added Site
WDM10 = CV	WDM4 = CX

### **Customer Impact of Change and Recommended Action:**

There will be no change to Form, Fit or Function, except reference to the manufacturing location as mentioned above.

Intel anticipates no impact to customers.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Milestone dates are estimates and subject to change based on business and operational conditions.

### **Products Affected / Intel Ordering Codes:**

Product Code	MM#	Pre Change TA	Post Change TA
633AN.HMWG	903689	E55085-020	E55085-021
633AN.HMWWB	903725	E78617-010	E78617-011
633AN.HMWIBC	921576	G62000-002	G62000-003
633AN.HMIG	931660	H15513-001	H15513-002

### **PCN Revision History:**

**Date of Revision:**

February 14, 2014

**Revision Number:**

00

**Reason:**

Originally Published PCN